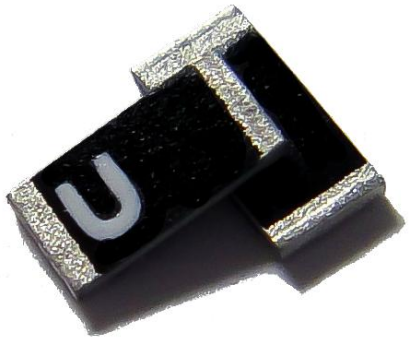
3.2 x 1.6 x 0.5 (mm) WiFi/Bluetooth Ceramic Chip Antenna (AA055K) Engineering Specification

1. Product Number

H	2	U	3	4	W	1	H	1	B	1	6	0	0



2. Features

*Stable and reliable in performances
*Low profile, compact size
*RoHS compliance
*SMT processes compatible

3. Applications

*ISM 2.4 GHz applications
*ZigBee/BLE applications
*Bluetooth earphone systems
*Hand-held devices when WiFi / Bluetooth functions are needed, e.g., Smart phones
*IEEE802.11 b/g/n
*Wireless PCMCIA cards or USB dongles

4. Description

Unictron's AA055K ceramic chip antenna is designed for ISM 2.4GHz applications, covering frequencies 2400~2500MHz. Fabricated with proprietary design and processes, AA055K shows excellent performance and is fully compatible with SMT processes which can decrease the assembly cost and improve device's quality and consistency.

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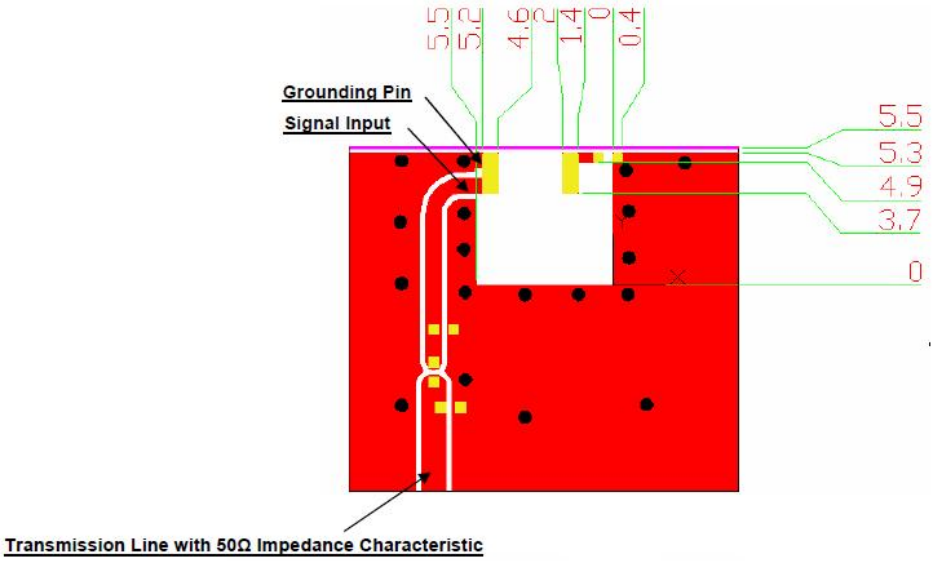
5. Layout Guide & Electrical Specifications

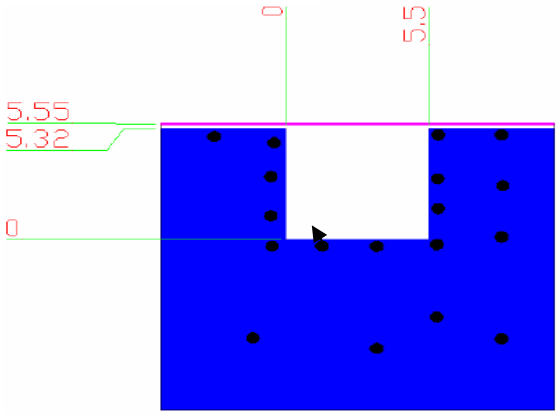
5-1. Layout Guide (unit:mm)

Solder Land Pattern:

The solder land pattern (gold marking areas) is shown below. Recommendation on matching circuit will be provided according to customer's installation conditions.



Top View



Bottom View

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5-2. Electrical Specifications (Evaluation Board Dimensions: 80 x 40 mm^2)

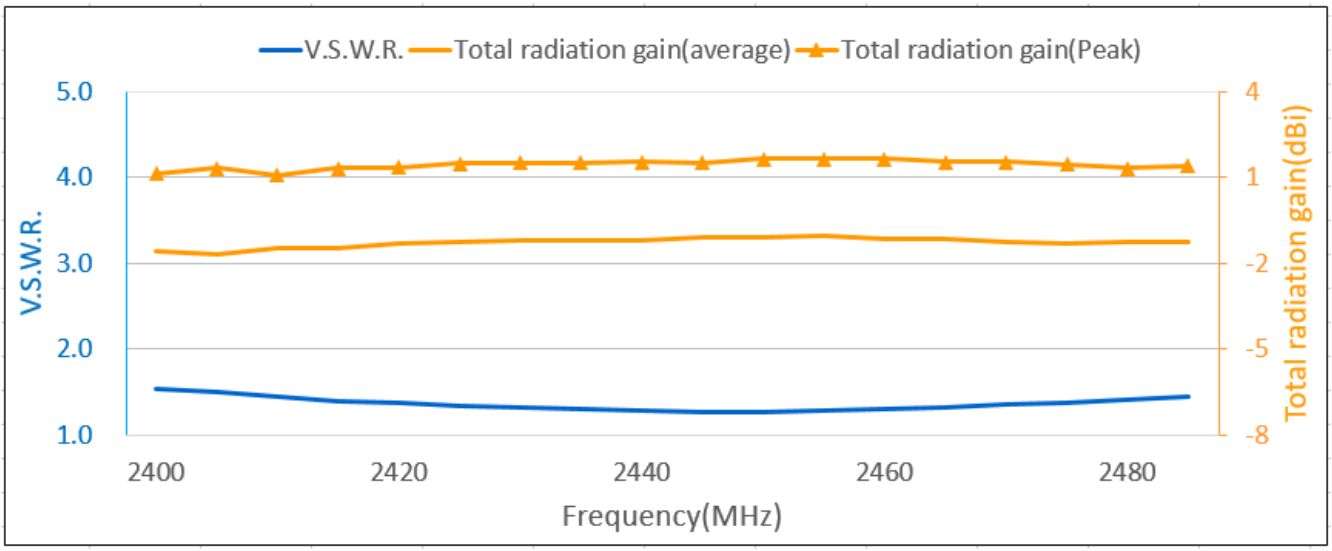
5-2-1. Electrical Table

Characteristics		Specifications	Unit
Outline Dimensions		3.2 x 1.6 x 0.5	mm
Ground Plane Dimensions		80 x 40	mm
Working Frequency		2400~2500	MHz
VSWR (@ center frequency)*		2 Max.	
Characteristic Impedance		50	Ω
Polarization		Linear Polarization	
Peak Gain	(@2442 MHz)	1.5 (typical**)	dBi
Efficiency		75 (typical**)	%

*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board.

**A typical value is for reference only, not guaranteed.

5-2-2. Frequency vs. V.S.W.R. and Total Radiation Gain



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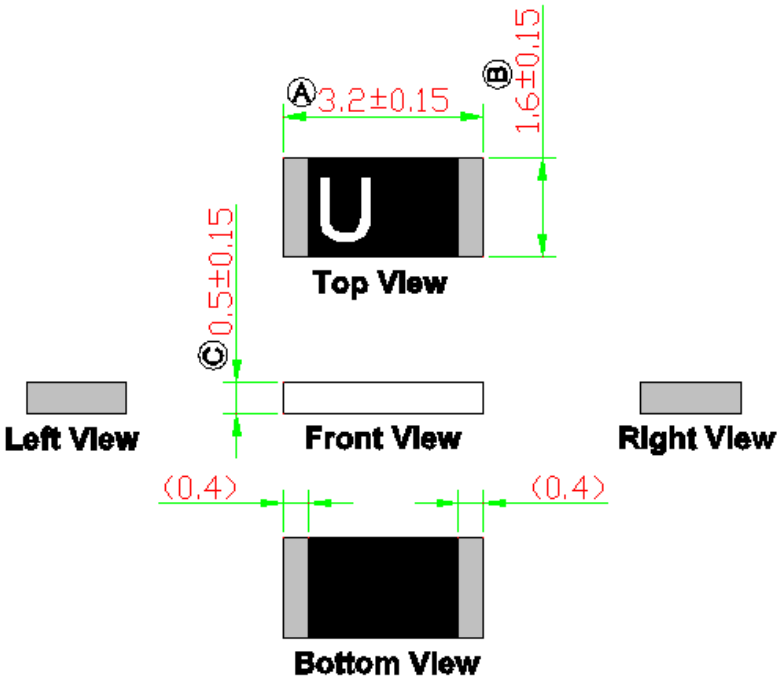
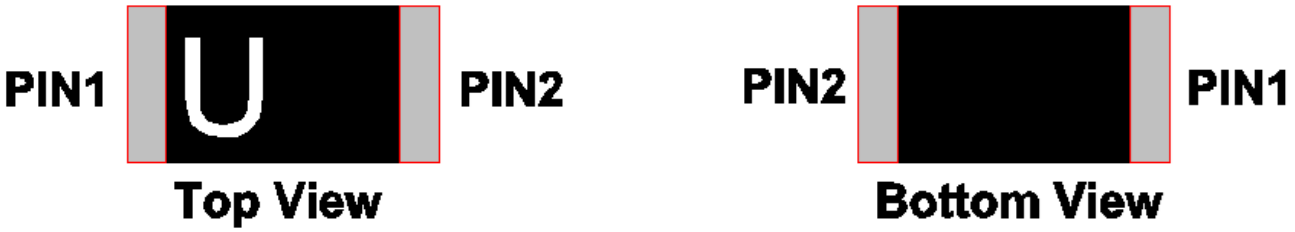
6. Outline Dimensions of Antenna & Evaluation Board (unit: mm)

6-1. Antenna Dimensions



NOTE:
1.All materials are RoHS compliant.
2."Ⓐ~Ⓒ" Critical Dimensions.
3."( )" Reference Dimensions.

PIN Definition



PIN	1	2
Soldering PAD	Signal	Tuning / Ground

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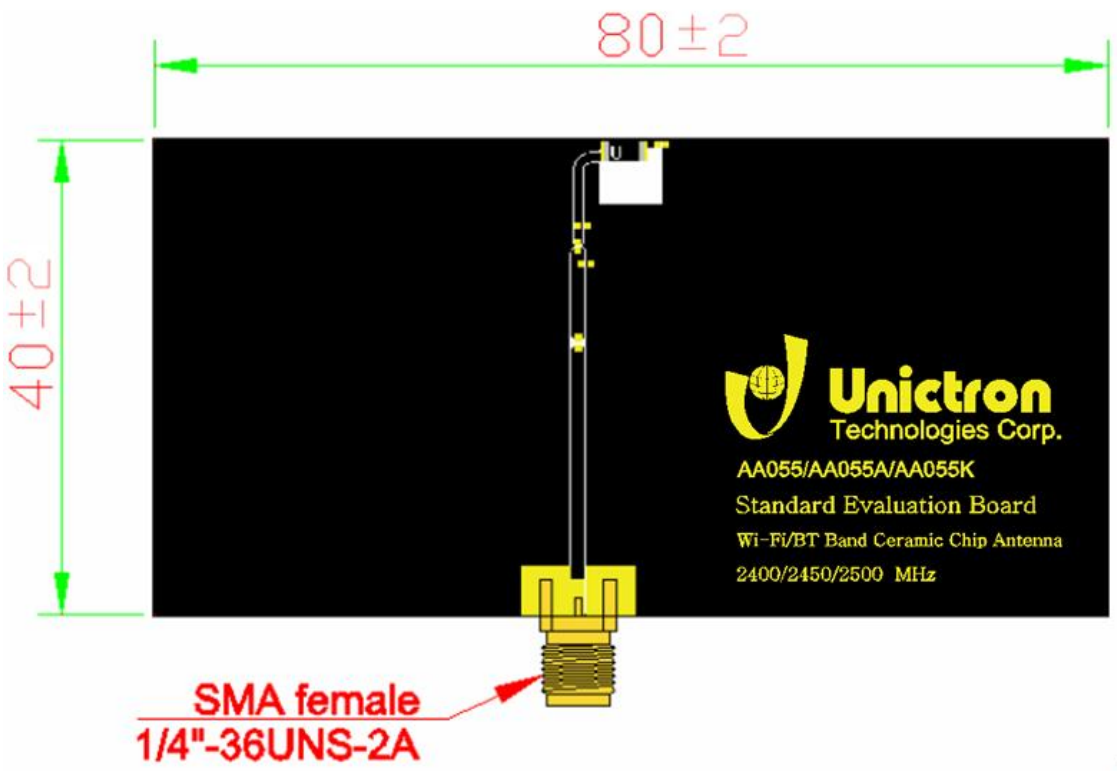
6-2. Evaluation Board with Antenna



unit : mm

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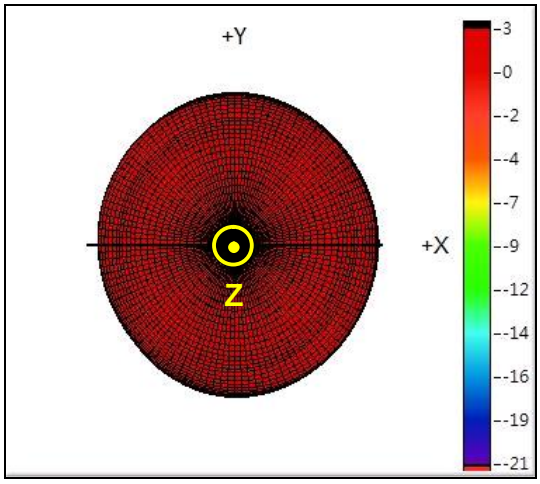
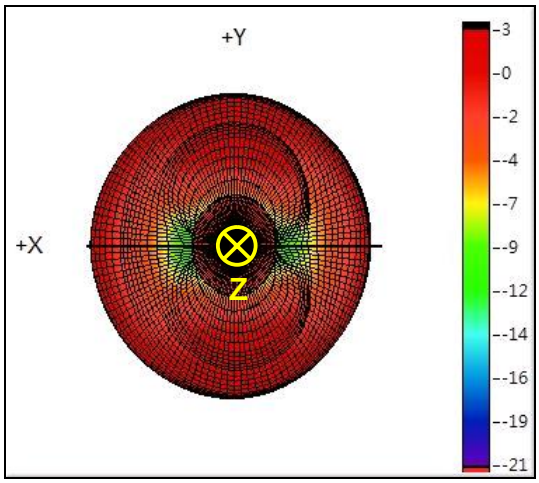
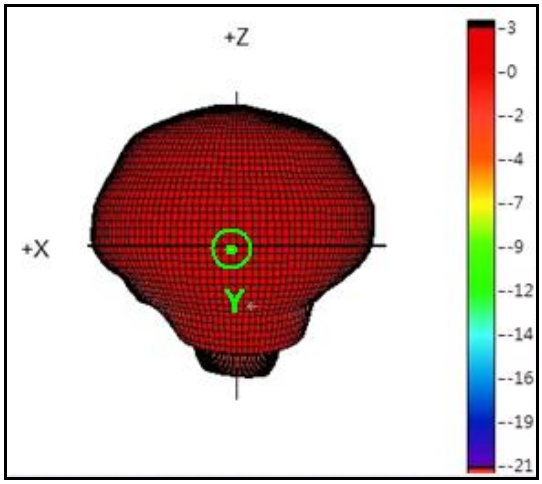
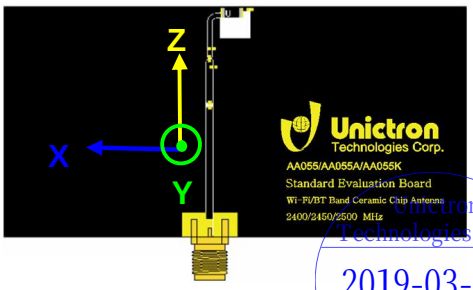
7. 3D Radiation Gain Pattern (with 80 x 40 mm² Evaluation Board)

3D Radiation Gain Pattern @ 2442 MHz (unit: dBi)









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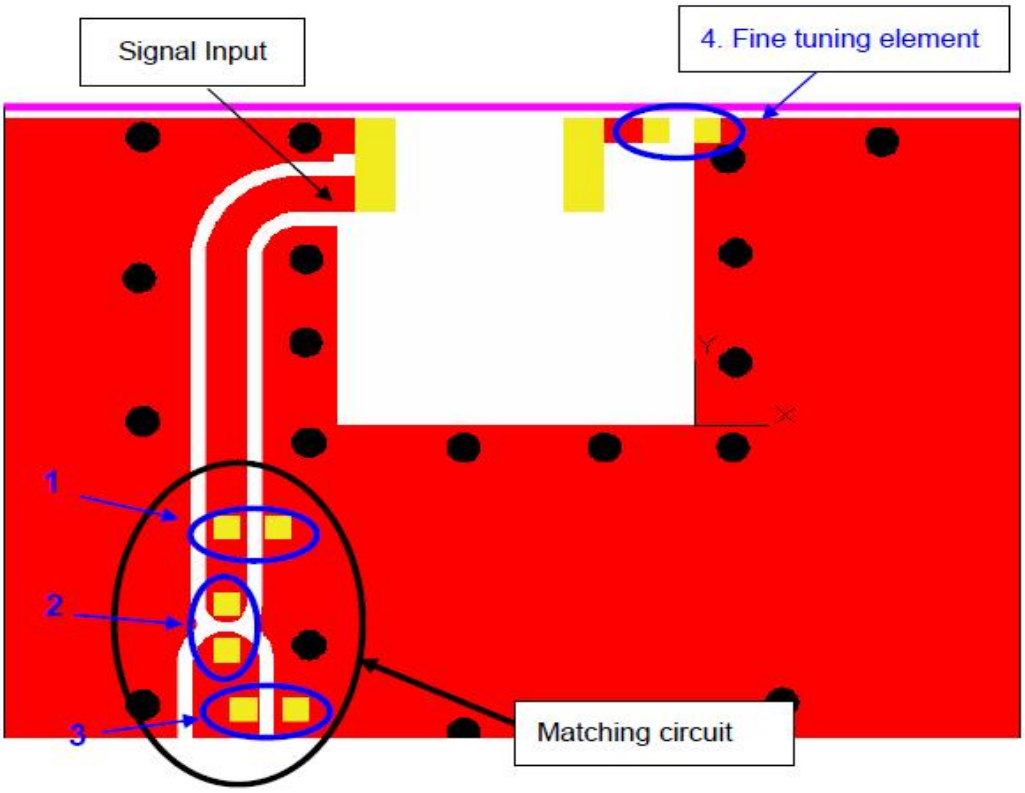
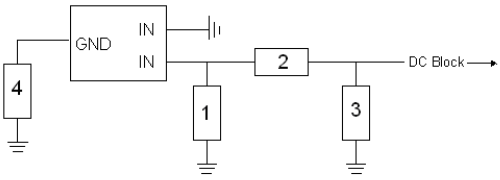
8. Frequency tuning and Matching circuit

8-1. Chip antenna tuning scenario：



8-2. Matching circuit：

With the following recommended values of matching and tuning components, the center frequencies will be about 2442 MHz at our standard 80x40 mm^2 evaluation board. However, these are typical reference values which may need to be changed when circuit boards or part vendors are different.



System Matching Circuit Component			
Location	Description	Vendor	Tolerance
1	1.2pF, (0402)	MURATA	±0.05 pF
2	3.3nH, (0402)	MURATA	±0.1 nH
3	NA		
Fine tuning element 4	1.2pF, (0402)	MURATA	±0.05 pF

*Typical reference values which may need to be changed when circuit boards or part vendors are different.

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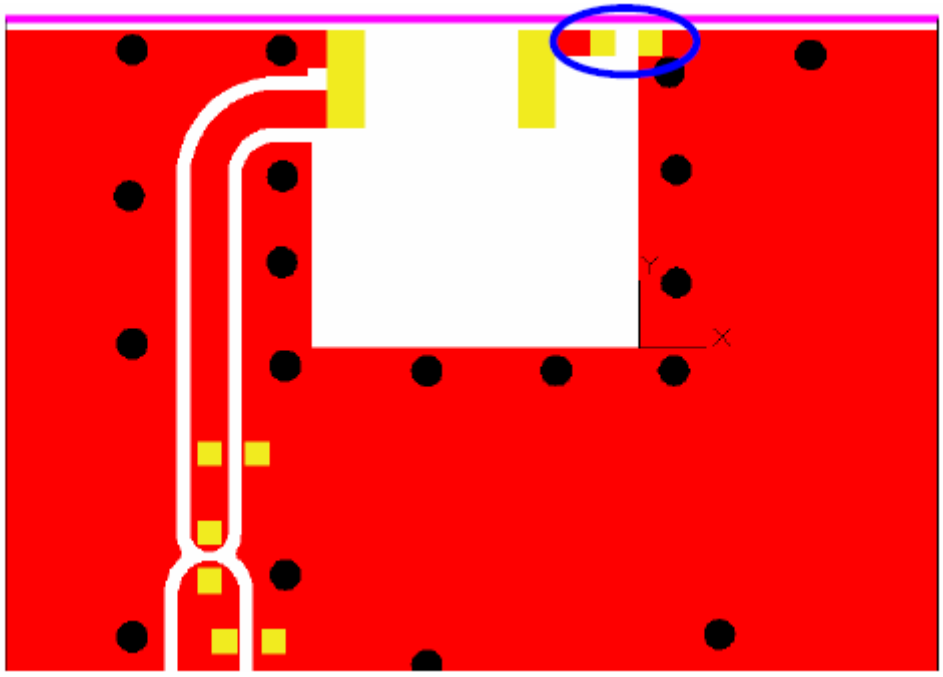
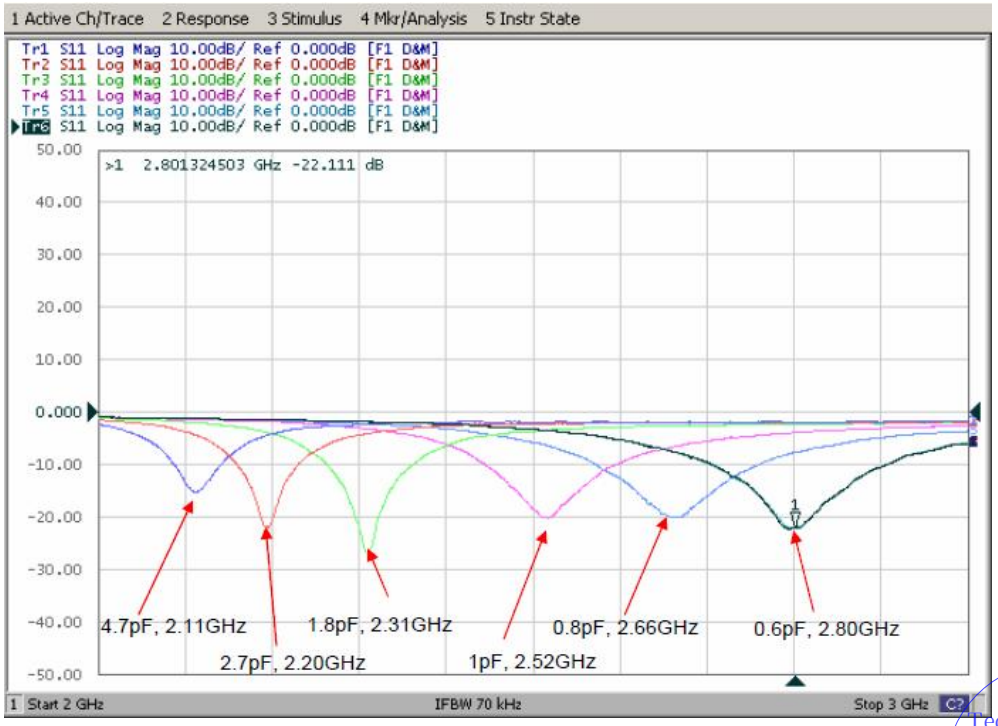
8-3. Reference for the frequency tuning element





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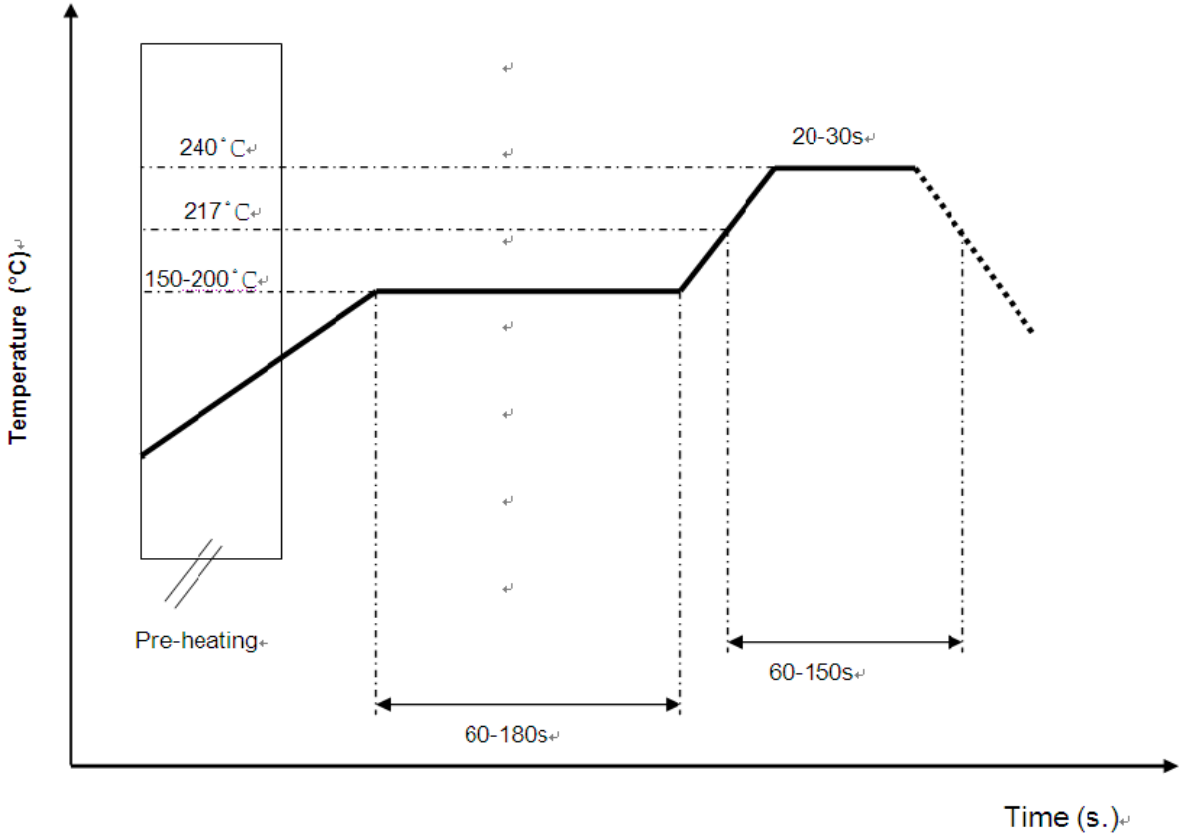
9. Soldering Condition

Solder paste alloy: SAC305 (Sn96.5/Ag3/Cu0.5) Lead Free solder paste



*Recommended solder paste alloy: SAC305 (Sn96.5 /Ag3 /Cu0.5) Lead Free solder paste

10. Reminders for users of Unictron's AA055K ceramic chip antennas

10-1. This chip antenna is made of ceramic materials which are relatively more rigid and brittle compared to printed circuit board materials. Bending of circuit board at the locations where chip antenna is mounted may cause the cracking of solder joints or antenna itself.

10-2. Punching/cutting of the break-off tab of PCB panel may cause severe bending of the circuit board which may result in cracking of solder joints or chip antenna itself. Therefore break-off tab shall be located away from the installation site of chip antenna.

10-3. Be cautious when ultrasonic welding process needs to be used near the locations where chip antennas are installed. Strong ultrasonic vibration may cause the cracking of chip antenna solder joints.

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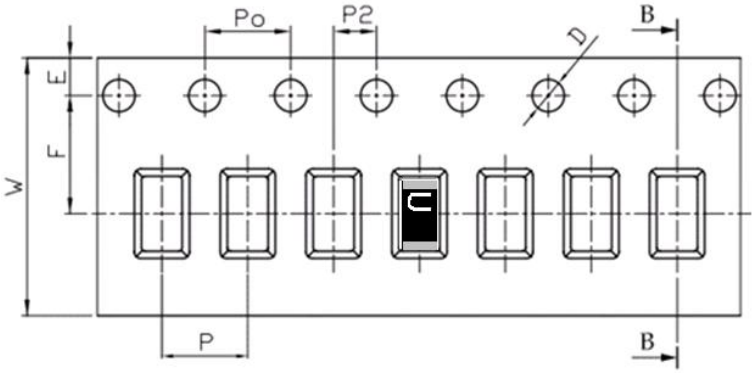
11. Packing

(1) Quantity/Reel: 5000 pcs/Reel

(2) Plastic tape: Black conductive polystyrene.

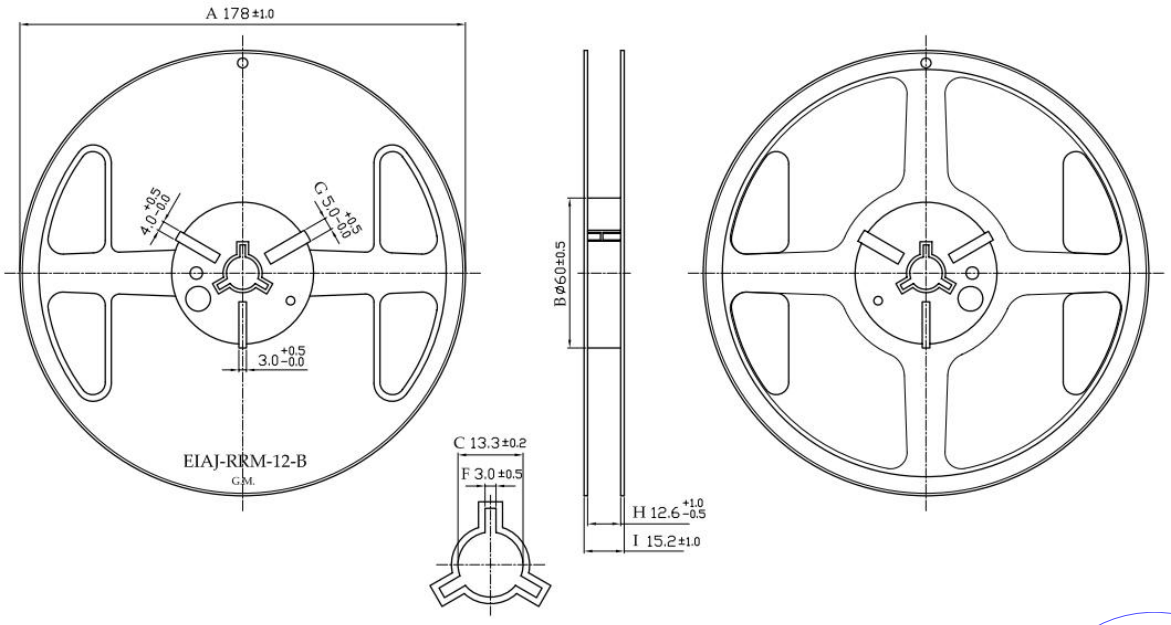
a. Tape Drawing



b. Tape Dimensions (unit: mm)

Feature	Specifications	Tolerances
W	12.00	±0.30
P	4.00	±0.10
E	1.75	±0.10
F	5.50	±0.10
P2	2.00	±0.10
D	1.50	+0.10 -0.00
Po	4.00	±0.10
10Po	40.00	±0.20

c. Reel Drawing



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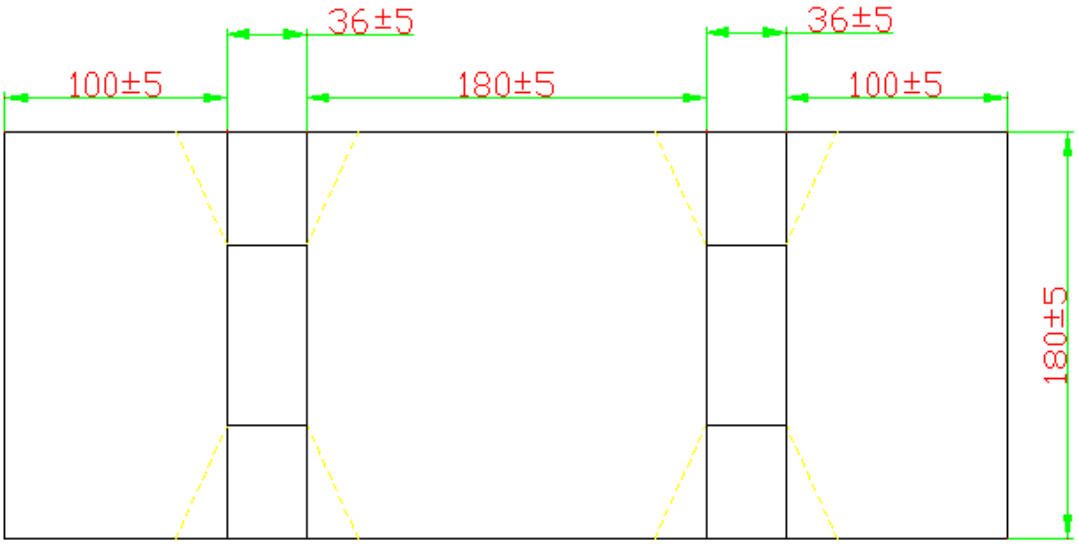
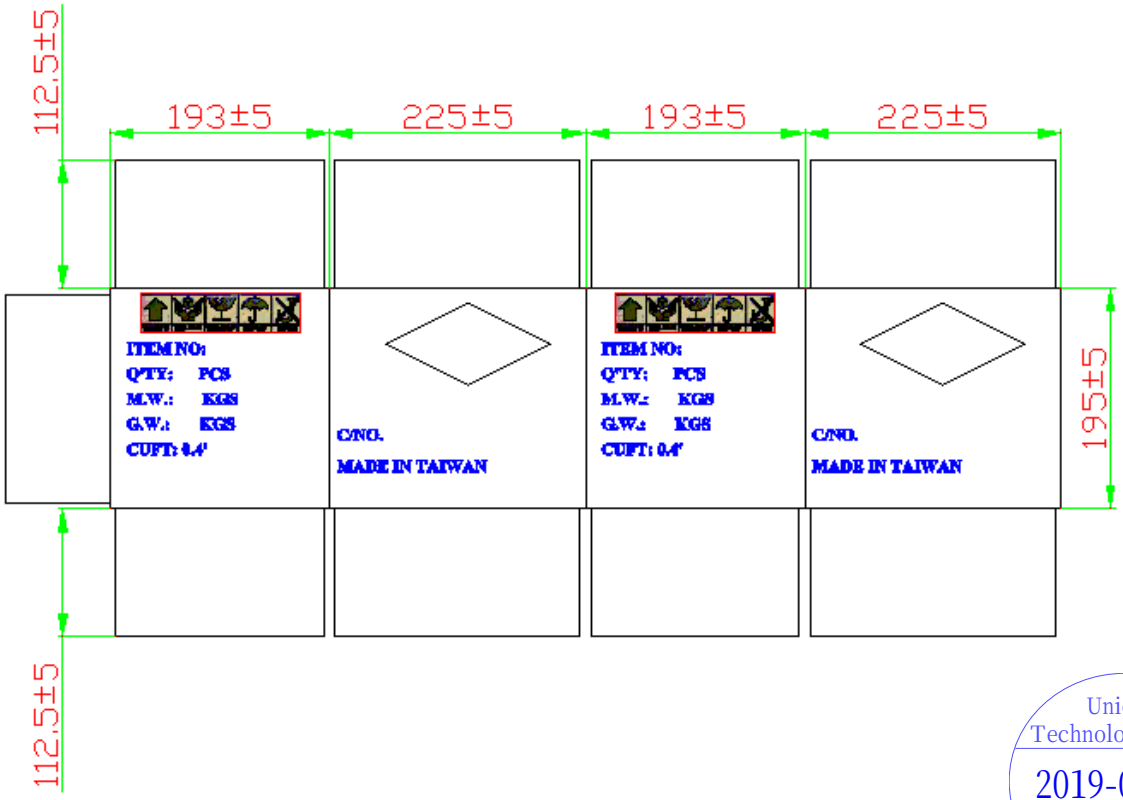
d. Drawing of small size carton in developed view



e. Drawing of middle size carton in developed view



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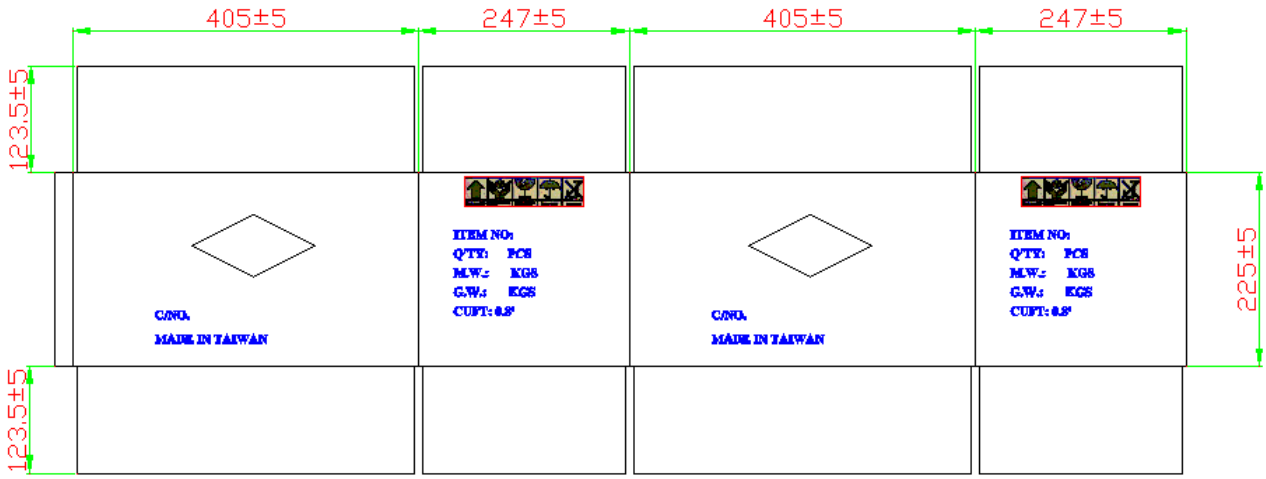
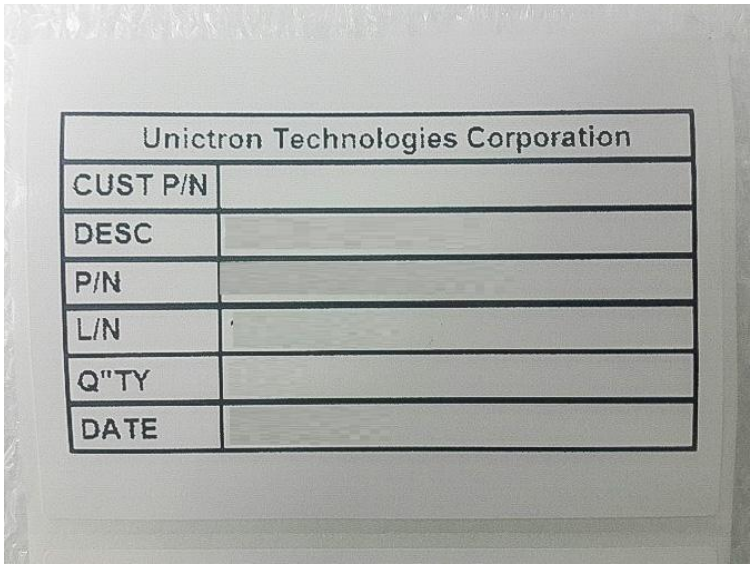
f. Drawing of large size carton in developed view



g. Picture of label



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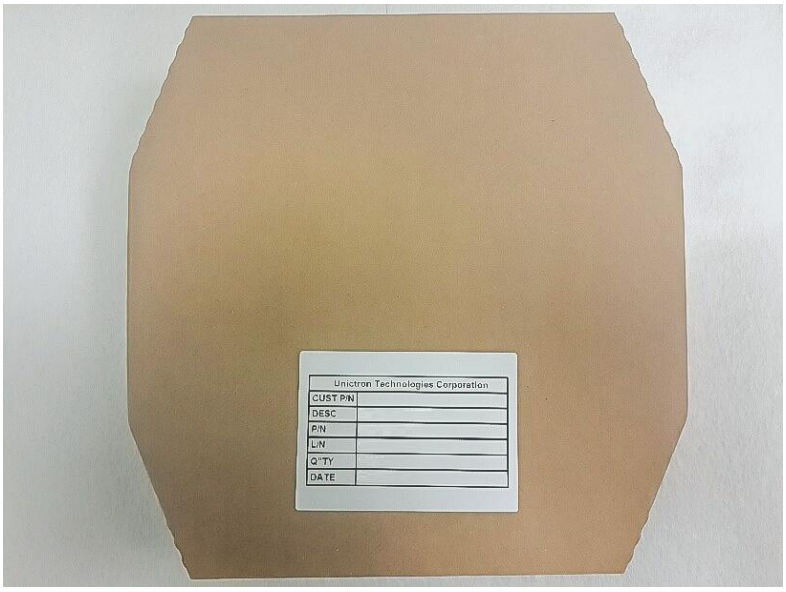
h. Reel with label

i. Small size carton with label



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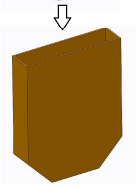
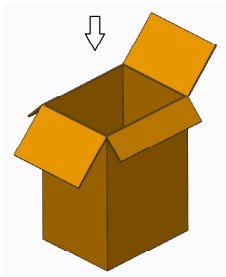
j. Middle size carton with label

11-2. Process of packing

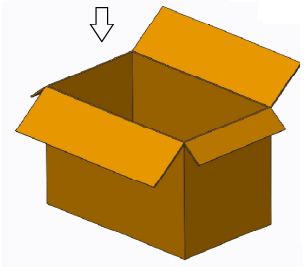
1 reel includes 5,000pcs(max.) chip antennas



1 small size carton includes 2pcs(max.) reels



1 middle size carton includes 5pcs(max.) small catons



1 large size carton includes 2pcs(max.) middle cartons

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12. Operating & Storage Conditions

12-1. Operating

(1) Maximum Input Power: 2 W

(2) Operating Temperature: -40℃ to 85℃

(3) Relative Humidity: 10% to 70%

12-2. Storage (sealed)

(1) Storage Temperature: -5℃ to 40℃

(2) Relative Humidity: 20% to 70%

(3) Shelf Life: 1 year

12-3. Storage (unsealed)

Meet the criteria of J-STD-033 MSL2a

12-4. Storage (After mounted on customer's PCB with SMT process)

(1) Storage Temperature: -40℃ to 85℃

(2) Relative Humidity: 10% to 70%

13. Notice

(1) Installation Guide:

Please refer to Unictron's application note "General guidelines for the installation of Unictron's chip antennas" for further information.

(2) All specifications are subject to change without notice.

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